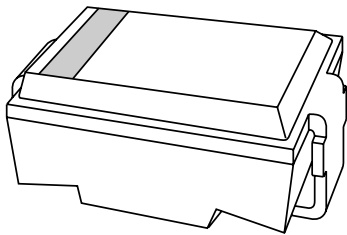


DATA SHEET



BZG04 series Transient voltage suppressor diodes

Product specification
Supersedes data of 1996 Sep 19

2002 Jul 04

Transient voltage suppressor diodes

BZG04 series

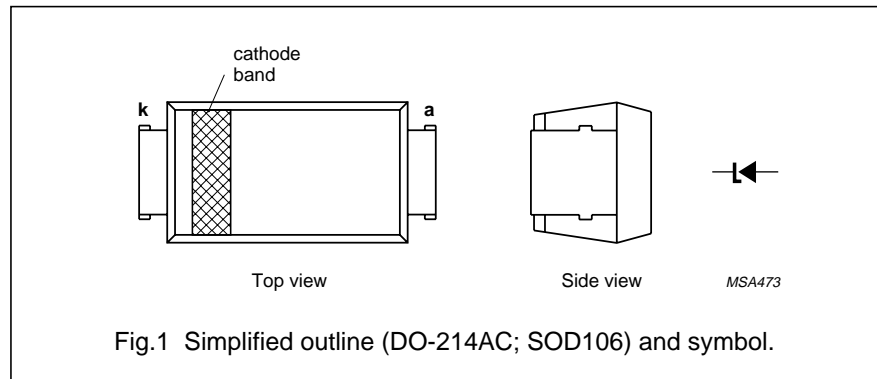
FEATURES

- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- UL 94V-O classified plastic package
- Transient suppressor stand-off voltage range:
8.2 to 220 V for 32 types
- Shipped in 12 mm embossed tape.

DESCRIPTION

DO-214AC surface mountable package with glass passivated chip.

The well-defined void-free case is of a transfer-moulded thermo-setting plastic.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
P_{RSM}	non-repetitive peak reverse power dissipation	10/1000 μ s exponential pulse (see Fig.4); $T_j = 25^\circ\text{C}$ prior to surge; see also Fig.2	–	300	W
T_{stg}	storage temperature		–65	+175	$^\circ\text{C}$
T_j	junction temperature		–65	+175	$^\circ\text{C}$

Transient voltage suppressor diodes

BZG04 series

ELECTRICAL CHARACTERISTICS

Total series

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_F	forward voltage	$I_F = 0.5\text{ A}$; see Fig.3	–	1.2	V

Per type

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

TYPE NUMBER	REVERSE BREAKDOWN VOLTAGE	TEMPERATURE COEFFICIENT		TEST CURRENT	CLAMPING VOLTAGE		REVERSE CURRENT at STAND-OFF VOLTAGE	
	$V_{(BR)R}$ (V) at I_{test}	S_Z (%/K) at I_{test}		I_{test} (mA)	$V_{(CL)R}$ (V) MAX.	at I_{RSM} (A) note 1	I_R (μA)	at V_R (V)
		MIN.	MAX.				MAX.	
BZG04-8V2	9.4	0.05	0.09	50	14.8	20.3	20	8.2
BZG04-9V1	10.4	0.05	0.10	50	15.7	19.1	5	9.1
BZG04-10	11.4	0.05	0.10	50	17.0	17.7	5	10
BZG04-11	12.4	0.05	0.10	50	18.9	15.9	5	11
BZG04-12	13.8	0.05	0.10	50	20.9	14.4	5	12
BZG04-13	15.3	0.06	0.11	25	22.9	13.1	5	13
BZG04-15	16.8	0.06	0.11	25	25.6	11.7	5	15
BZG04-16	18.8	0.06	0.11	25	28.4	10.6	5	16
BZG04-18	20.8	0.06	0.11	25	31.0	9.7	5	18
BZG04-20	22.8	0.06	0.11	25	33.8	8.9	5	20
BZG04-22	25.1	0.06	0.11	25	38.1	7.9	5	22
BZG04-24	28	0.06	0.11	25	42.2	7.1	5	24
BZG04-27	31	0.06	0.11	25	46.2	6.5	5	27
BZG04-30	34	0.06	0.11	10	50.1	6.0	5	30
BZG04-33	37	0.06	0.11	10	54.1	5.5	5	33
BZG04-36	40	0.07	0.12	10	60.7	4.9	5	36
BZG04-39	44	0.07	0.12	10	65.5	4.6	5	39
BZG04-43	48	0.07	0.12	10	70.8	4.2	5	43
BZG04-47	52	0.07	0.12	10	78.6	3.8	5	47
BZG04-51	58	0.08	0.13	10	86.5	3.5	5	51
BZG04-56	64	0.08	0.13	10	94.4	3.2	5	56
BZG04-62	70	0.08	0.13	10	103.5	2.9	5	62
BZG04-68	77	0.08	0.13	10	114	2.6	5	68
BZG04-75	85	0.09	0.13	5	126	2.4	5	75
BZG04-82	94	0.09	0.13	5	139	2.2	5	82
BZG04-91	104	0.09	0.13	5	152	2.0	5	91
BZG04-100	114	0.09	0.13	5	167	1.8	5	100
BZG04-110	124	0.09	0.13	5	185	1.6	5	110
BZG04-120	138	0.09	0.13	5	204	1.5	5	120
BZG04-130	153	0.09	0.13	5	224	1.3	5	130

Transient voltage suppressor diodes

BZG04 series

TYPE NUMBER	REVERSE BREAKDOWN VOLTAGE	TEMPERATURE COEFFICIENT		TEST CURRENT	CLAMPING VOLTAGE		REVERSE CURRENT at STAND-OFF VOLTAGE	
	$V_{(BR)R}$ (V) at I_{test}	S_Z (%/K) at I_{test}		I_{test} (mA)	$V_{(CL)R}$ (V)	at I_{RSM} (A) note 1	I_R (μ A)	at V_R (V)
	MIN.	MIN.	MAX.		MAX.		MAX.	
BZG04-150	168	0.09	0.13	5	249	1.2	5	150
BZG04-160	188	0.09	0.13	5	276	1.1	5	160
BZG04-180	208	0.09	0.13	2	305	1.0	5	180
BZG04-200	228	0.09	0.13	2	336	0.9	5	200
BZG04-220	251	0.09	0.13	2	380	0.8	5	220

Note

1. Non-repetitive peak reverse current in accordance with "IEC 60-1, Section 8" (10/1000 μ s pulse); see Fig.4.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-tp}$	thermal resistance from junction to tie-point		25	K/W
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	100	K/W
		note 2	150	K/W

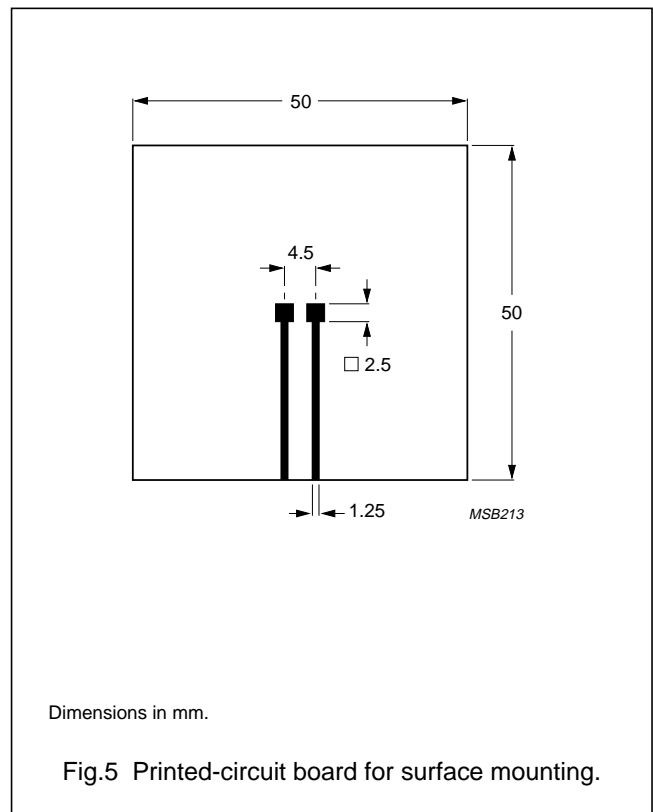
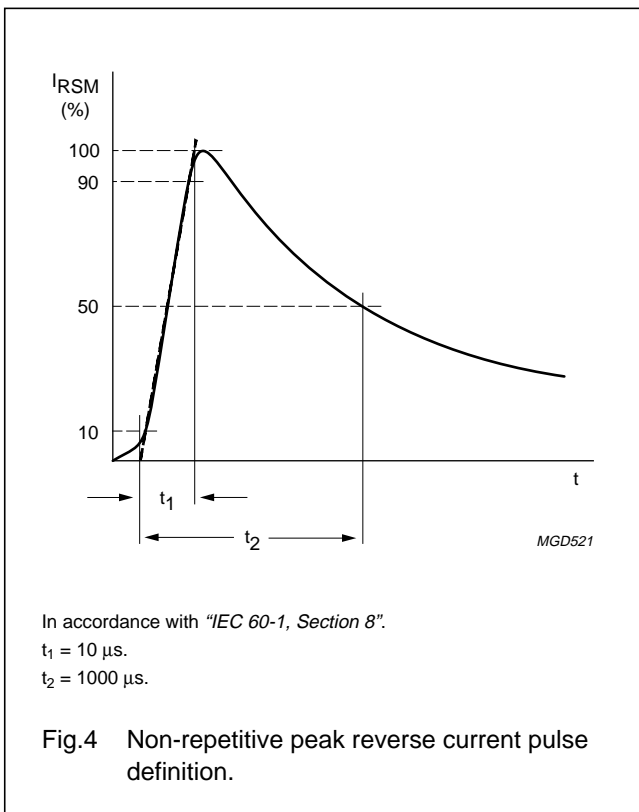
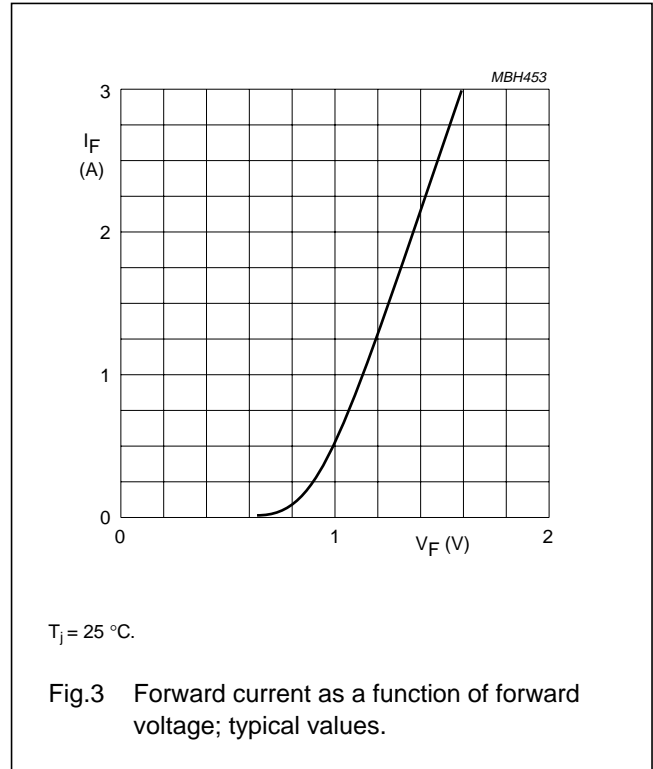
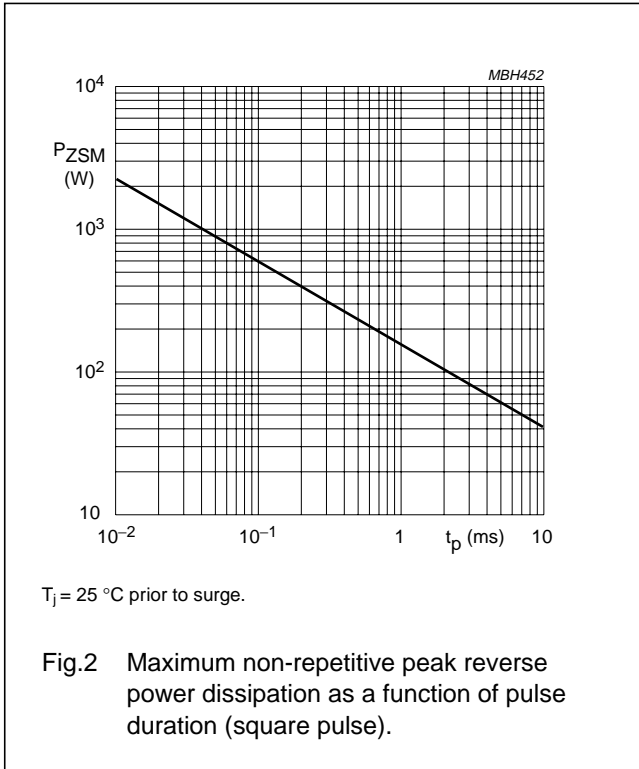
Notes

1. Device mounted on an Al_2O_3 printed-circuit board, 0.7 mm thick; thickness of Cu-layer ≥ 35 μ m, see Fig.5.
2. Device mounted on an epoxy-glass printed-circuit board, 1.5 mm thick; thickness of Cu-layer ≥ 40 μ m, see Fig.5. For more information please refer to the "General Part of associated Handbook".

Transient voltage suppressor diodes

BZG04 series

GRAPHICAL DATA



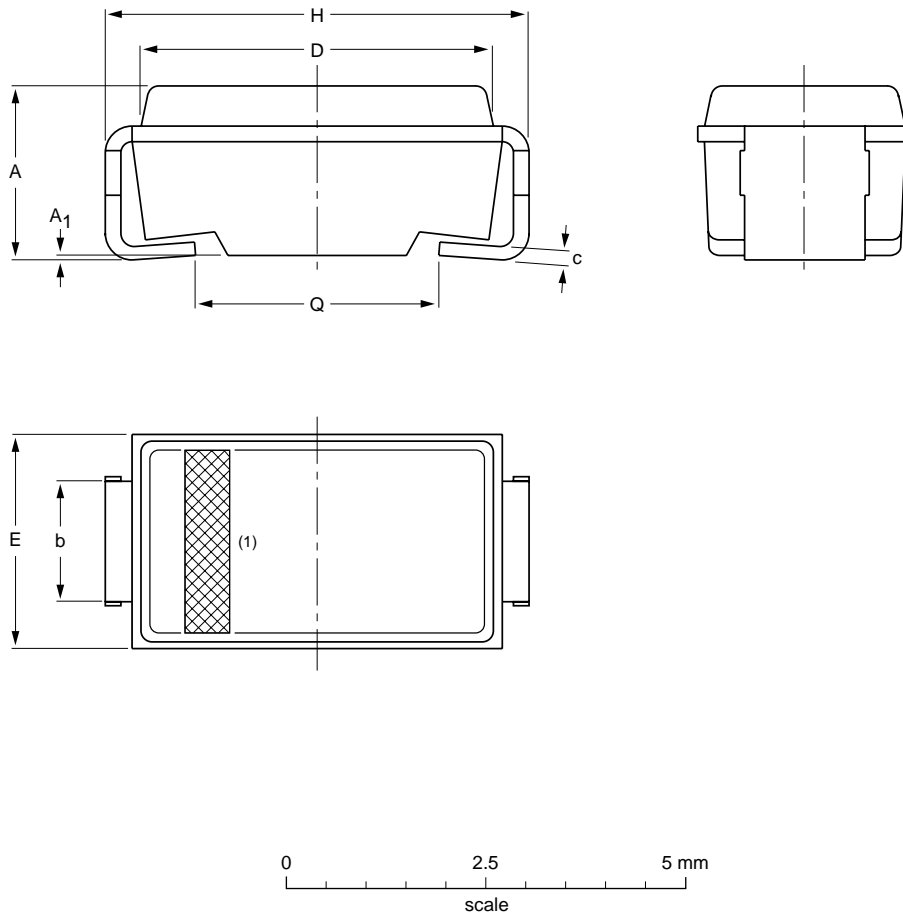
Transient voltage suppressor diodes

BZG04 series

PACKAGE OUTLINE

Transfer-moulded thermo-setting plastic small rectangular surface mounted package;
2 connectors

SOD106



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b	c	D	E	H	Q
mm	2.3 2.0	0.05	1.6 1.4	0.2	4.5 4.3	2.8 2.4	5.5 5.1	3.3 2.7

Note

1. The marking band indicates the cathode.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOD106		DO-214AC			97-06-09

Transient voltage suppressor diodes

BZG04 series

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

1. Please consult the most recently issued data sheet before initiating or completing a design.
2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

DISCLAIMERS

Life support applications — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors – a worldwide company

Contact information

For additional information please visit <http://www.semiconductors.philips.com>. Fax: +31 40 27 24825

For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

© Koninklijke Philips Electronics N.V. 2002

SCA74

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

613514/04/pp8

Date of release: 2002 Jul 04

Document order number: 9397 750 09765

Let's make things better.

**Philips
Semiconductors**



PHILIPS